2-input NAND gate Rev. 04 — 11 July 2007

1. General description

The 74HC1G00 and 74HCT1G00 are high speed Si-gate CMOS devices. They provide a 2-input NAND function.

The HC device has CMOS input switching levels and supply voltage range 2 V to 6 V.

The HCT device has TTL input switching levels and supply voltage range 4.5 V to 5.5 V.

The standard output currents are half those of the 74HC00 and 74HCT00.

2. Features

- Symmetrical output impedance
- High noise immunity
- Low power dissipation
- Balanced propagation delays
- SOT353-1 and SOT753 package options

3. Ordering information

Table 1. Ordering information

Type number	Package						
	Temperature range	Name	Description	Version			
74HC1G00GW	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads;	SOT353-1			
74HCT1G00GW			body width 1.25 mm				
74HC1G00GV	–40 °C to +125 °C SC-74A		plastic surface-mounted package; 5 leads	SOT753			
74HCT1G00GV							

4. Marking

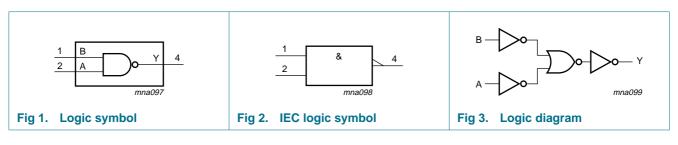
Table 2.Marking codes

Type number	Marking
74HC1G00GW	НА
74HCT1G00GW	ТА
74HC1G00GV	H00
74HCT1G00GV	Т00



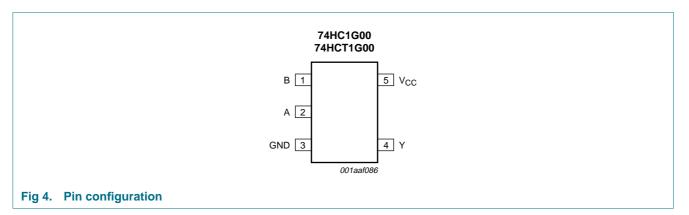
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5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
В	1	data input
А	2	data input
GND	3	ground (0 V)
Y	4	data output
V _{CC}	5	supply voltage

7. Functional description

Table 4.Function table

H = *HIGH* voltage level; *L* = *LOW* voltage level

Input		Output
Α	В	Y
L	L	Н
L	Н	Н
н	L	Н
Н	Н	L

74HC_HCT1G00_4

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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V). [1]

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
I _{IK}	input clamping current	V_{I} < -0.5 V or V_{I} > V_{CC} + 0.5 V	-	±20	mA
I _{OK}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	-	±20	mA
lo	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±12.5	mA
I _{CC}	supply current		-	25	mA
I _{GND}	ground current		-25	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$	[2] _	200	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] Above 55 °C the value of P_{tot} derates linearly with 2.5 mW/K.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	7	74HC1G00			74HCT1G00		
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage	'	2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V_{CC}	0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
	and fall rate	$V_{CC} = 4.5 V$	-	-	139	-	-	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

10. Static characteristics

Table 7. Static characteristics

Voltages are referenced to GND (ground = 0 V). All typical values are measured at T_{amb} = 25 °C.

0				-					
Symbol	Parameter	Conditions	-40	–40 °C to +85 °C			–40 °C to +125 °C		
			Min	Тур	Max	Min	Max		
For type	74HC1G00								
V _{IH}	HIGH-level input	$V_{CC} = 2.0 V$	1.5	1.2	-	1.5	-	V	
voltage	voltage	$V_{CC} = 4.5 V$	3.15	2.4	-	3.15	-	V	
		$V_{CC} = 6.0 V$	4.2	3.2	-	4.2	-	V	
V _{IL}	LOW-level input	$V_{CC} = 2.0 V$	-	0.8	0.5	-	0.5	V	
voltage	voltage	$V_{CC} = 4.5 V$	-	2.1	1.35	-	1.35	V	
		$V_{CC} = 6.0 V$	-	2.8	1.8	-	1.8	V	

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Symbol	Parameter	Conditions	-40	–40 °C to +85 °C			–40 °C to +125 °C	
			Min	Тур	Max	Min	Max	
V _{он}	HIGH-level output	$V_{I} = V_{IH}$ or V_{IL}						
	voltage	$I_{O} = -20 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$	1.9	2.0	-	1.9	-	V
		$I_{O} = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	4.5	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	V
		I_{O} = -2.0 mA; V_{CC} = 4.5 V	4.13	4.32	-	3.7	-	V
		$I_{O} = -2.6 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.63	5.81	-	5.2	-	V
V _{OL}	LOW-level output	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	voltage	$I_{O} = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	V
		I_{O} = 2.0 mA; V_{CC} = 4.5 V	-	0.15	0.33	-	0.4	V
		I_{O} = 2.6 mA; V_{CC} = 6.0 V	-	0.16	0.33	-	0.4	V
l _i	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	1.0	-	1.0	μΑ
сс	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V	-	-	10	-	20	μA
Cı	input capacitance		-	1.5	-	-	-	pF
For type	74HCT1G00							
/ _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	V
VIL	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	V
∕ _{он}	HIGH-level output	$V_I = V_{IH} \text{ or } V_{IL}$						
	voltage	$I_O = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	4.5	-	4.4	-	V
		I_{O} = -2.0 mA; V_{CC} = 4.5 V	4.13	4.32	-	3.7	-	V
∕ _{OL}	LOW-level output	$V_I = V_{IH} \text{ or } V_{IL}$						
	voltage	$I_{O} = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	V
		I_{O} = 2.0 mA; V_{CC} = 4.5 V	-	0.15	0.33	-	0.4	V
I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	1.0	-	1.0	μΑ
сс	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} \text{ or } GND; \ I_{O} = 0 \ A; \\ V_{CC} = 5.5 \ V \end{array}$	-	-	10	-	20	μA
2l ^{CC}	additional supply current	per input; V _{CC} = 4.5 V to 5.5 V; V _I = V _{CC} - 2.1 V; I _O = 0 A	-	-	500	-	850	μA
C _I	input capacitance		-	1.5	-	-	-	pF

Table 7. Static characteristics ... continued

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11. Dynamic characteristics

Table 8. Dynamic characteristics

GND = 0 V; $t_r = t_f \le 6.0$ ns; All typical values are measured at $T_{amb} = 25 \degree C$. For test circuit see Figure 6

		21	umo						
Symbol	Parameter	Conditions		–40 °C to +85		5 °C	–40 °C to +125 °C		Unit
			-	Min	Тур	Max	Min	Max	1
For type	74HC1G00	'							
t _{pd}	propagation delay	A and B to Y; see Figure 5	<u>[1]</u>						
		$V_{CC} = 2.0 \text{ V}; \text{ C}_{L} = 50 \text{ pF}$		-	25	115	-	135	ns
		$V_{CC} = 4.5 \text{ V}; \text{ C}_{L} = 50 \text{ pF}$		-	9	23	-	27	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	7	-	-	-	ns
		$V_{CC} = 6.0 \text{ V}; \text{ C}_{L} = 50 \text{ pF}$		-	8	20	-	23	ns
C _{PD}	power dissipation capacitance	$V_I = GND$ to V_{CC}	[2]	-	19	-	-	-	pF
For type	e 74HCT1G00								
t _{pd}	propagation delay	A and B to Y; see Figure 5	<u>[1]</u>						
		$V_{CC} = 4.5 \text{ V}; \text{ C}_{L} = 50 \text{ pF}$		-	12	24	-	27	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	10	-	-	-	ns
C _{PD}	power dissipation capacitance	$V_{\rm I}$ = GND to $V_{\rm CC}-$ 1.5 V	[2]	-	21	-	-	-	pF

 $\label{eq:tpd} [1] \quad t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}.$

[2] C_{PD} is used to determine the dynamic power dissipation P_D (µW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

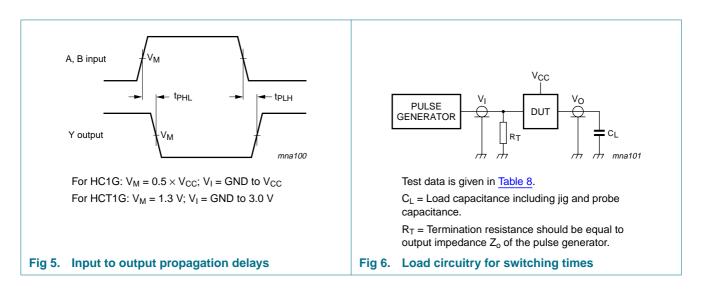
 f_i = input frequency in MHz; f_o = output frequency in MHz

 C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

 $\Sigma~(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs

12. Waveforms



2-input NAND gate

13. Package outline

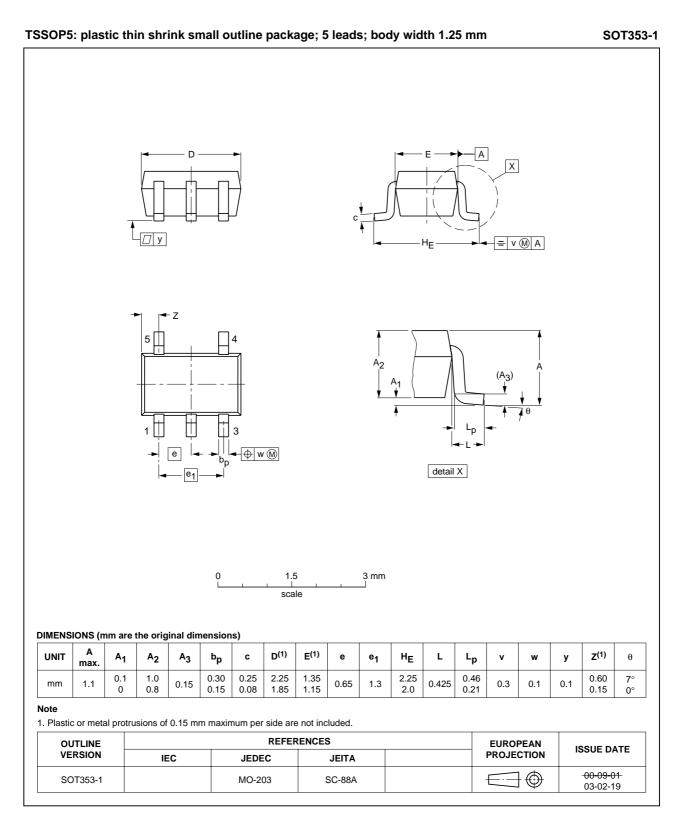


Fig 7. Package outline SOT353-1 (TSSOP5)

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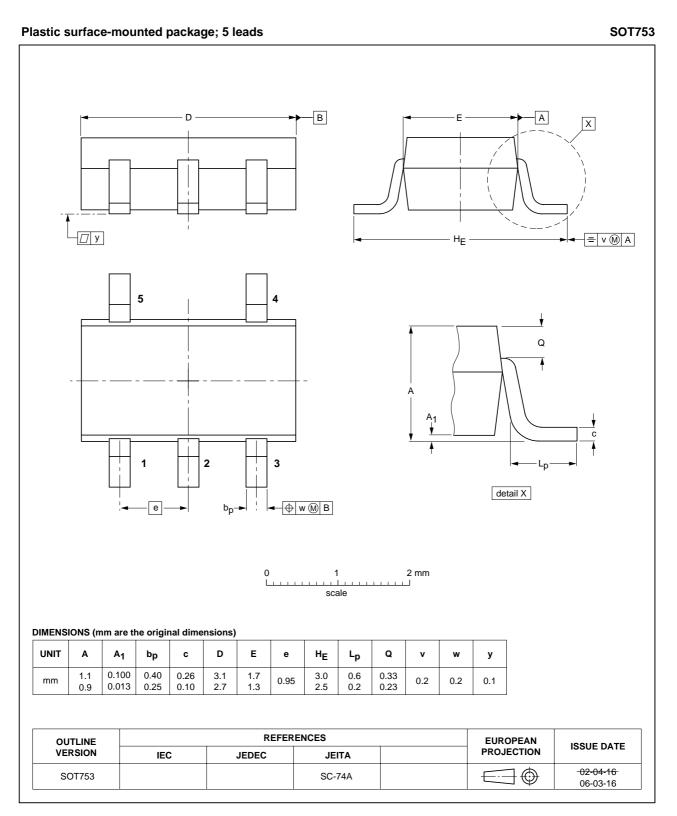


Fig 8. Package outline SOT753 (SC-74A)

14. Abbreviations

Table 9.	Abbreviations		
Acronym	Description		
DUT	Device Under Test		
TTL	Transistor-Transistor Logic		

15. Revision history

Table 10.Revision history

	-			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT1G00_4	20070711	Product data sheet	-	74HC_HCT1G00_3
Modifications:		t of this data sheet has been re of NXP Semiconductors.	edesigned to comply v	with the new identity
	 Legal texts 	s have been adapted to the ne	w company name whe	ere appropriate.
	 Package S 	OT353 changed to SOT353-1	in Section 3 and Sect	tion 13.
	 Quick refe 	rence data and Soldering sect	ions removed.	
	Section 2	"Features" updated.		
74HC_HCT1G00_3	20020515	Product specification	-	74HC_HCT1G00_2
74HC_HCT1G00_2	20010302	Product specification	-	74HC_HCT1G00_1
74HC_HCT1G00_1	19980730	Preliminary specification	-	-

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16.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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2-input NAND gate

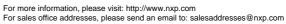
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